

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Koos et al.

Atty Dkt No.: NOVLP068/NVLS-

000818

Application No.: 10/690,084

Examiner: UNASSIGNED

Filed: October 20, 2003

Group: 1763

Title: METHOD FOR FABRICATION OF SEMICONDUCTOR INTERCONNECT

STRUCTURE WITH REDUCED CAPACITANCE,

LEAKAGE CURRENT, AND IMPROVED

BREAKDOWN VOLTAGE

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on August 3, 2004 in an envelope addressed of the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 2231-1450.

Signed: ___

Joyce L. Ferreira

AMENDMENT TRANSMITTAL

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Transmitted herewith is an Amendment in the above-identified application.

The fee has been calculated as shown below.

	Claims After Amendment		Highest Previously Paid For	Present Extra	Small Entity Rate Fee	Large Entity Rate Fee
Total Claims	66	MINUS	47	19	x 9 =	x 18 = 342.00
Independent Claims	05	MINUS	03	02	x 43 =	x 86 = 172.00
Multiple Dependent Claim Present and Fee Not Previously Paid					\$145.00	\$290.00
				Total	\$	\$514.00

Applicant(s) believe that no (additional) Extension of Time is required; however, if it is determined that such an extension is required, Applicant(s) hereby petition that such an extension be granted and authorize the Commissioner to charge the required fees for an Extension of Time under 37 CFR 1.136 to Deposit Account No. 500388.

Enclosed is our Check No.9456 in the amount of \$514.00 to cover the additional claim fee and/or extension of time fees.

Please charge the required fees, or any additional fees required to facilitate filing the enclosed response, to Deposit Account No. 500388 (Order No. NOVLP068).

Respectfully submitted,

BEYER WEAVER & THOMAS, LLP

P.O. Box 778 Berkeley, CA 94704-0778

Jeffrey K. Weaver Reg. No. 31,314 In re application of: Koos et al.

Attorney Docket No.:

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Signed:

Joyce L. Ferreira

PRELIMINARY AMENDMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Before examination on its merits, please amend the above-identified patent application as follows:

Amendments to the Claims are reflected in the listing of claims which being on page 2 of this paper.

Remarks/Arguments begin on page 8 of this paper.

08/09/2004 MMEKONEN 00000023 10690084

01 FC:1201 02 FC:1202

172.00 OP 342.00 OP